

Multilayer 6 Layers

PCB Thickness : 1,67 mm +/- 10%

Rigid area Structure	Rigid area Thickness	Material description		Via types	Layer usage	Impedance	
						Er	Z[Ohm] Line / Space
Soldermask	15					3,5	
L1	45	* Incl. Plating	Top Layer		100 Ohm/50 Ohm		
	230	FR4 TG 135				3,9	
L2	35				100 Ohm/50 Ohm		
	360	FR4 TG 135				4,1	
L3	35				Power		
	230	FR4 TG 135				3,9	
L4	35				Power		
	360	FR4 TG 135				4,1	
L5	35				100 Ohm/50 Ohm		
	230	FR4 TG 135				3,9	
L6	45	* Incl. Plating	Bottom Layer		Power		
Soldermask	15					3,5	